

FORM PTO-1449 INFORMATION DISCLOSURE CITATION				Attorney Docket: 4024-4044US2		Serial No.: To Be Assigned	
				Applicant: John Trezza			
				Filing Date: September 30, 2003		Group Art Unit: To Be Assigned	
U.S. PATENT DOCUMENTS							
Examiner Initial	Patent Number	Publication Date	Name	Class	Sub-Class	Filing Date	
DW	4,533,833	August 6, 1985	Copeland et al.			August 19, 1982	
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Examiner				Date Considered 8/15/05			
EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP §609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to Applicant.							

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	6,005,262	December 21, 1999	Cunningham			January 27, 1998
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	Pub. No. US2002/0141011	Publication Date: October 2002	Green et al.			

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Examiner Initial	Patent Number	Publication Date	Country	Class	Sub-Class	Translation
						<input type="checkbox"/> Yes <input type="checkbox"/> No
						<input type="checkbox"/> Yes <input type="checkbox"/> No
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OTHER DOCUMENTS (continued)

OTHER DOCUMENTS (continued)	
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Examiner	Date Considered 8/15/05
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